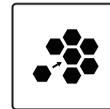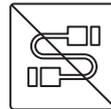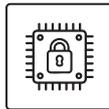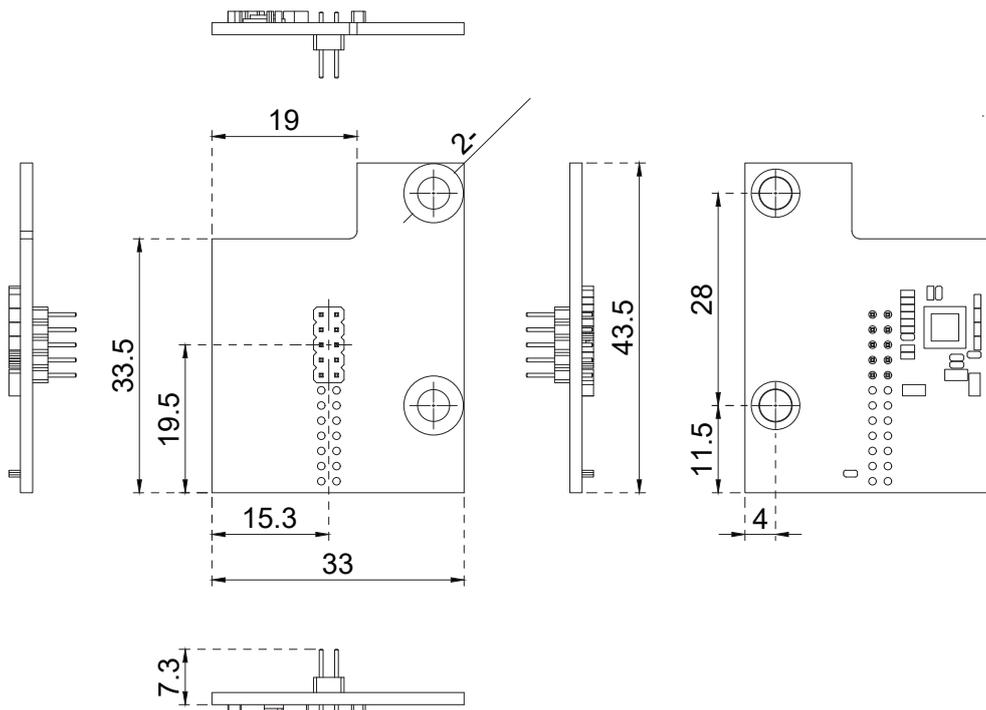# CFM-TPM02

CFM Module with Hardware TPM 2.0

- Hardware-based TPM 2.0 Module
- Built-in Infineon SLB9672 Chipset, Supporting Hardware-based Cryptographic Operations And Secure Key Storage

Specifications

TPM Version	▪ TPM 2.0
TPM Chipset	▪ Infineon SLB9672
Dimension (W x D x H)	▪ 43.5 x 33 x 7.3 mm

Dimensions

Unit: mm

Ordering Information

Available Models

Model No.	Description
CFM-TPM02-R10	CFM Module with Hardware TPM 2.0

Package Checklist

- CFM Module x1
- CFM Module Cable x1
- Screw Pack x1

Compatible List

Platform	Model
Intel® Arrow Lake-S Core Ultra Series 2	DX-1300